

**PNP Type Bipolar Transistor**

**Features**

- Low profile package
- Ideal for automated placement
- Power Dissipation of 300mW
- High Stability and High Reliability
- RoHS Compliant

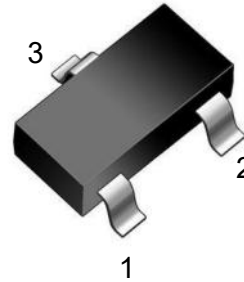
**Mechanical Data**

- Package: SOT-23
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020

**Applications**

- Amplifying Signal
- Electronic switch
- Oscillating circuit
- Variable resistance

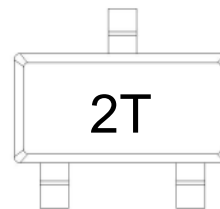
**Appearance&Symbol**



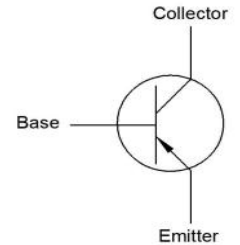
Package: SOT-23

- 1: Base
- 2: Emitter
- 3: Collector

**Marking Information**



Marking Code :2T



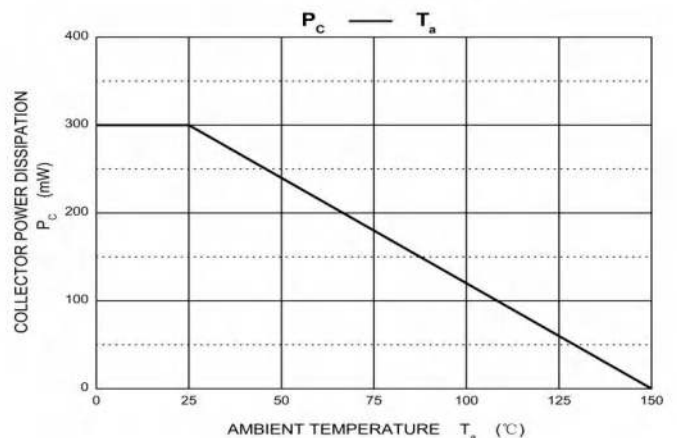
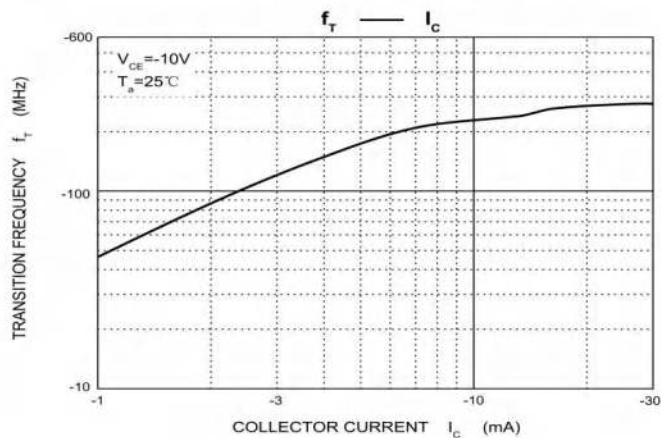
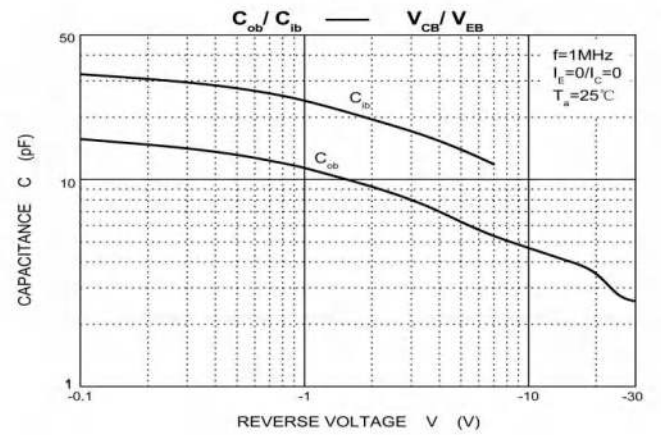
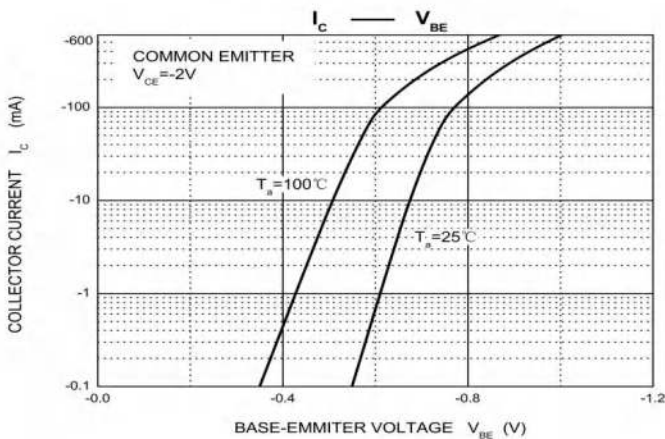
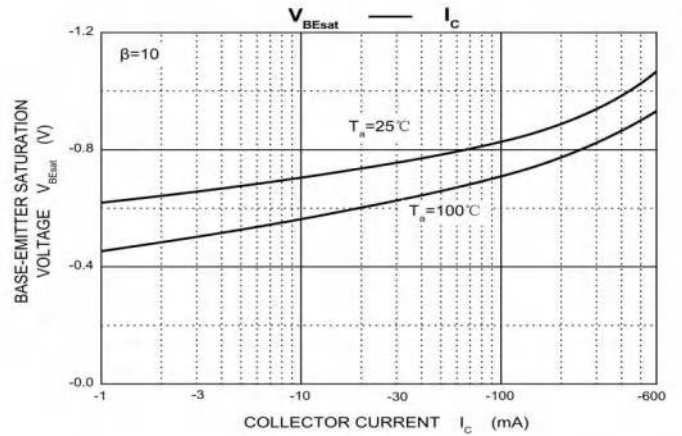
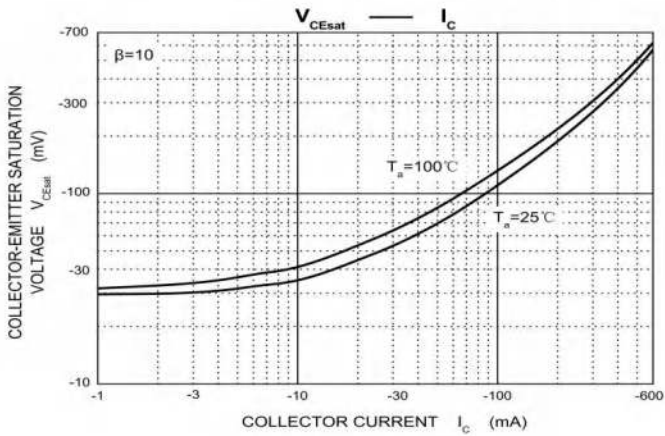
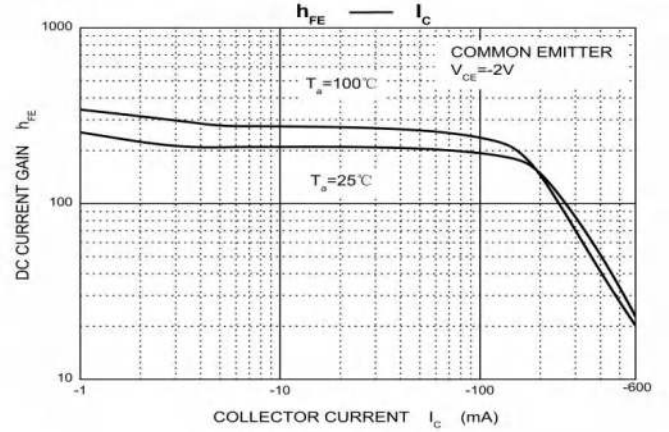
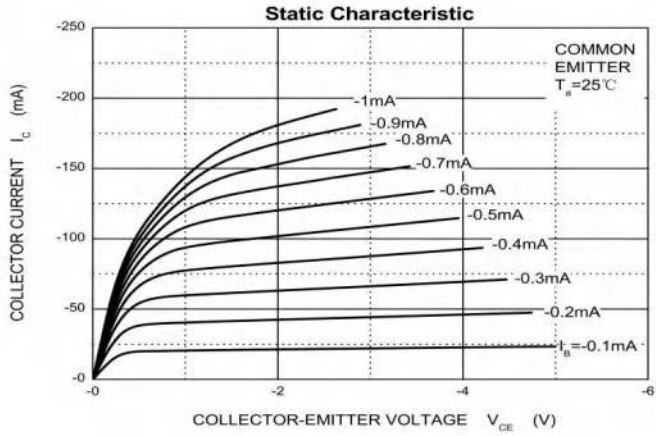
**Absolute Maximum Ratings(T=25°C, RH=45%-75%, unless otherwise noted)**

Parameters	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-40	V
Collector-Emitter Voltage	$V_{CEO}$	-40	V
Emitter-Base Voltage	$V_{EBO}$	-5	V
Collector Current Continuous	$I_C$	-600	mA
Collector Power Dissipation	$P_C$	300	mW
Thermal Resistance From Junction to Ambient	$R_{\theta JA}$	500	°C/W
Junction Temperature	$T_J$	-55 to +150	°C
Junction and Storage Temperature	$T_{STG}$	-55 to +150	°C

## Electrical Characteristics(T=25°C, RH=45%-75%, unless otherwise noted)

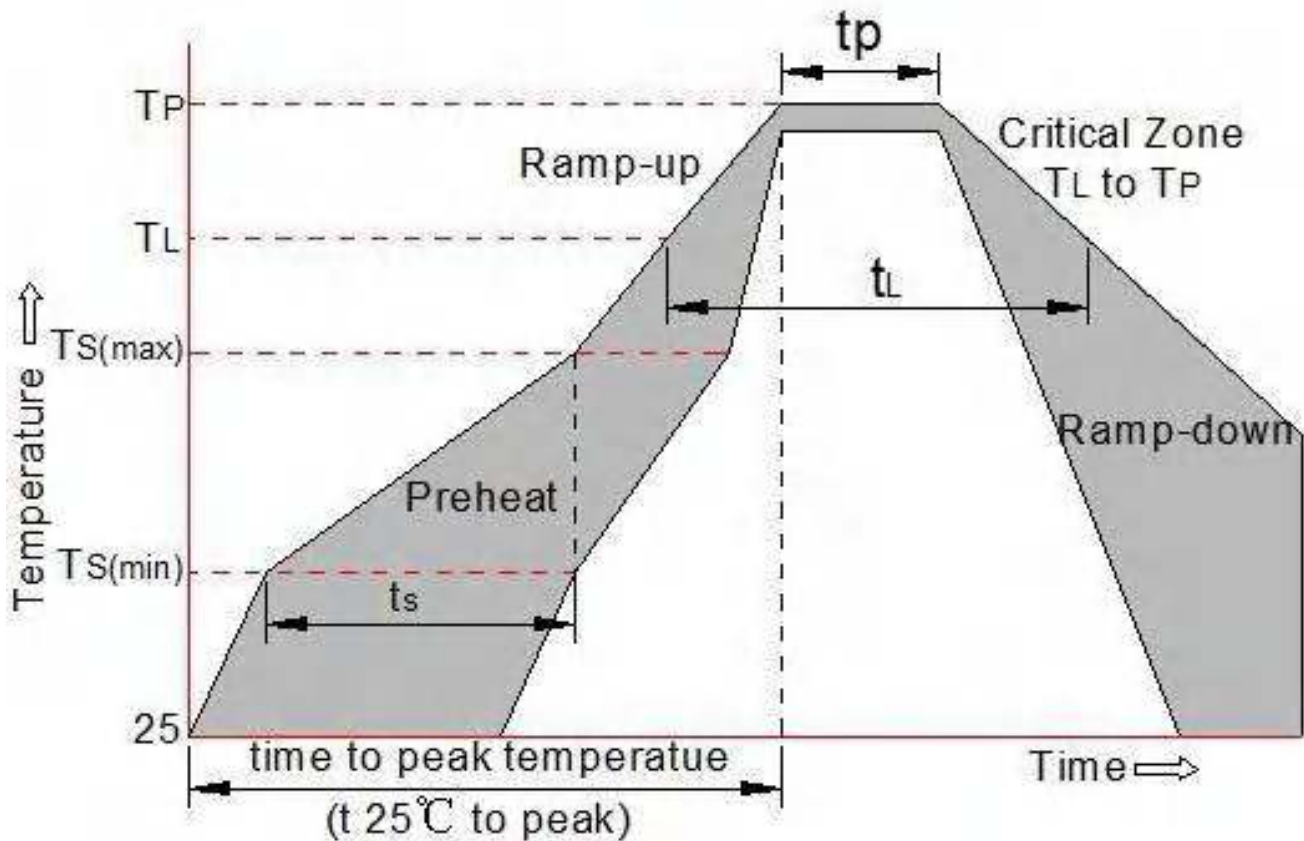
Parameters	Symbol	Test Condition	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=-100\mu A, I_E=0$	-40		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=-1mA, I_B=0$	-40		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=-100\mu A, I_C=0$	-5		V
Collector cut-off current	$I_{CBO}$	$V_{CB}=-35V, I_E=0$		-100	nA
Emitter cut-off current	$I_{EBO}$	$V_{EB}=-4V, I_C=0$		-100	nA
Collector cut-off current	$I_{CEX}$	$V_{CE}=-35V, V_{BE}=-0.4V$		-100	nA
DC current gain	$h_{EF(1)}$	$V_{CE}=-1V, I_C=-0.1mA$	30		
	$h_{EF(2)}$	$V_{CE}=-1V, I_C=-1mA$	60		
	$h_{EF(3)}$	$V_{CE}=-1V, I_C=-10mA$	100		
	$h_{EF(4)}$	$V_{CE}=-2V, I_C=-150mA$	100	300	
	$h_{EF(5)}$	$V_{CE}=-2V, I_C=-500mA$	20		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=-150mA, I_B=-15mA$		-0.4	V
		$I_C=-500mA, I_B=-50mA$		-0.75	V
Base -emitter saturation voltage	$V_{BE(sat)}$	$I_C=-150mA, I_B=-15mA$		-0.95	V
		$I_C=-500mA, I_B=-50mA$		-1.3	V
Transition frequency	$f_T$	$V_{CE}=-10V, I_C=-20mA, f=100MHz$	200		MHz
Delay time	$t_d$	$V_{CC}=-30V, V_{BE(off)}=-0.5V, I_C=-150mA, I_{B1}=-15mA$		15	ns
Rise time	$t_r$			20	ns
Storage time	$t_s$	$V_{CE}=-30V, I_C=-150mA, I_{B1}=I_{B2}=-15mA$		225	ns
Fall time	$t_f$			60	ns

# RATING AND CHARACTERISTICS CURVES (MMBT4403)

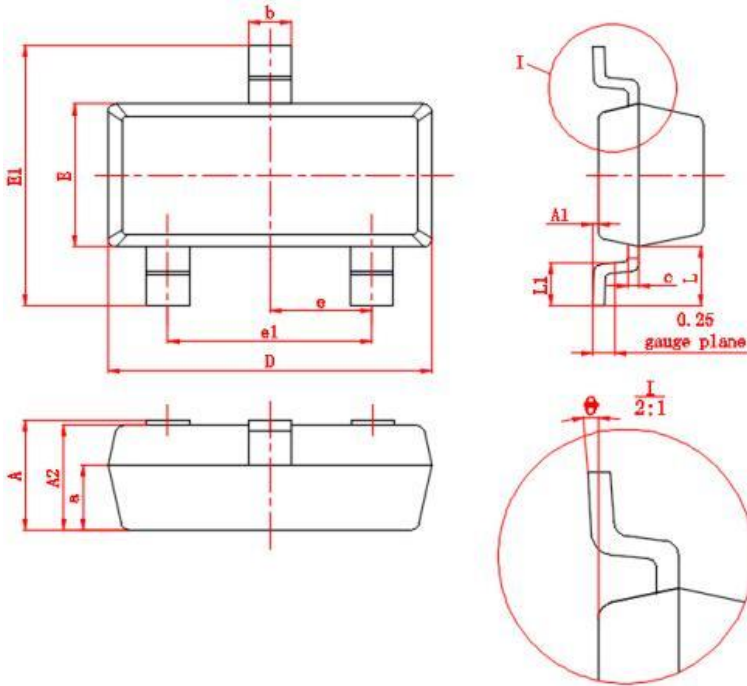


## Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) ( $t_s$ )	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C

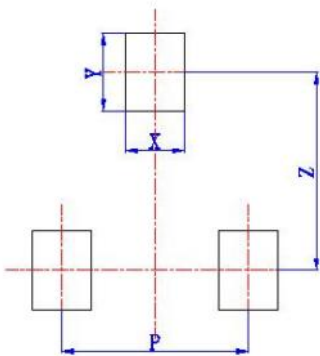


## Package mechanical data



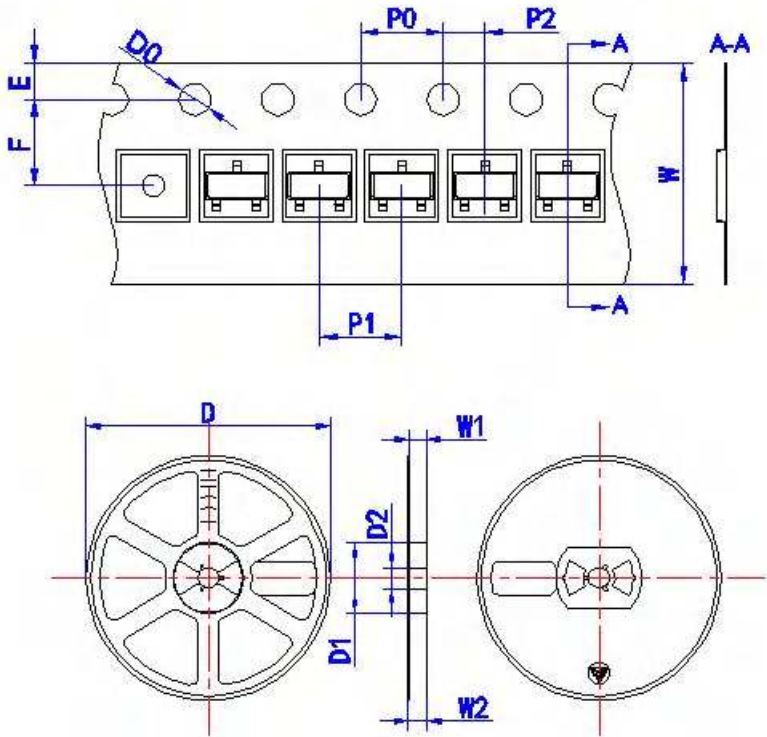
Symbol	Dimension in Millimeters	
	Min	Max
A	0.9	1.15
A1	0	0.1
A2	0.9	1.05
a	(0.6)	
D	2.8	3.0
E	1.2	1.4
E1	2.25	2.55
e	(0.95)	
e1	1.8	2.0
b	0.3	0.5
c	0.08	0.15
L	(0.55)	
L1	0.3	0.5
$\theta$	$0^\circ$	$8^\circ$

## Suggested Land Pattern



Symbol	Dimension in Millimeters
	Typ
X	(0.6)
Y	(0.8)
Z	(2.02)
P	(1.9)

## Tape & reel specification



Symbol	Dimension in Millimeters
<b>Tape</b>	
D0	1.50+0.10/-0.00
E	1.75±0.10
F	3.50±0.10
P0	4.00±0.10
P1	4.00±0.10
P2	2.00±0.10
W	8.00+0.3/-0.1
<b>Reel</b>	
D	178.0±2.00
D1	54.40±1.00
D2	13.00±1.00
W1	9.50±1.00
W2	12.30±1.00

### REEL PACK

PACKAGE	PACKING CODE	REEL ( EA )	COMPONENT SPACE(mm)	TAPE SPACE (mm)	REEL DIA (mm)	CARTON SIZE (mm)	EA PER CARTON	GROSS WEIGHT(Kg)
SOT-23/-3L	-T	3,000	---	---	178	438*438*220	180,000	7.93

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